Transverse Beam Profile Analysis of a Plasma Sputter Ion Source

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ABSTRACT

The beam profile of an existing plasma-sputter-type negative ion source with a titanium target is analyzed. The transverse characteristics of the ion beam are investigated and the deposition capability of the system is characterized. The ambient plasma parameters are derived via a Langmuir probe indicating an electronic density of $9.2 \times 10^{16}$ cm$^{-3}$ and temperature of $2.14 \times 10^4$ K near the center of the ion beam. Simulated negative ion distributions show that the energy content of the deposition plasma is three orders of magnitude lower than the expected current amplitude—the apparent effect of beam defocus. Although attenuation of the incident beam is apparent, the beam is basically monoenergetic, with a maximum energy spread of 8 eV.

INTRODUCTION

It has long been recognized that surface coatings offer increased opportunity to select materials most appropriate in providing excellent resistance to corrosion, wear, fatigue, and friction (Bunshah, 1982; Walther et al., 1990). Lately, there is notable interest in titanium ion Ti deposition because of its remarkable durability, making it important as a coating material on tools to extend their lifetime (Jiang et al., 1995; Scardi et al., 1991). Titanium films prepared on silicon have also been used as diffusion barriers for very large scale integrated (VLSI) circuits and as wear-resistant ceramic coatings (Sundgren et al., 1985).

So far, many coating techniques, such as chemical vapor deposition (CVD), physical vapor deposition (PVD) and ion plating, have been used to prepare Ti layers (Kajioka et al., 1996; Ahmed, 1994; Kadlee et al., 1989). However, films produced by these conventional techniques often exhibit poor adhesion to the substrates. A significant trend that has been used is the ion-beam-assisted deposition techniques in growing surface layers. It has shown significant advantages because of the freedom with which materials can be modified by adjusting the ion current or energy of an independent ion beam. This method has improved adhesion to the substrate and enabled growing films at low temperature by the aid of energetic ions (Rossmagel and Cuomo, 1987; Smidt, 1990). Thus, ion beam-assisted deposition has become an effective means of growing high-quality films.

A major detriment to this deposition process is the low-electron affinity of Ti, which poses a formidable problem in ion coating because a significant magnitude of the plasma flux is mandatory for proper deposition. Therefore, there is a need for appropriate beam characterization as functions of the various plasma operating parameters. The critical dependence of the application on the amount of impurities and on strict energy requirements constrain us to develop a technique to investigate the depository beam. In particular, we investigate the transverse energy density characteristics of the Ti ions and evaluate whether the ion flux is high enough to achieve proper deposition. This is implemented using an electrostatic energy analyzer.

Key words: plasma physics, film deposition

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(ESA) with a typical current density of 0.25 nA/mm². The ESA is interfaced to a computer via a GPIB driver to permit the rapid and accurate determination of the energy density. The dependence of the beam characteristics on the operating conditions (electron temperature, density and plasma space potential) is investigated via a Langmuir probe. The plasma source geometry is described in Sec. II and the experimental results are given in Sec. III. The feasibility of the facility for ion deposition is then evaluated in the last section.

METHODOLOGY

A layout of the facility is shown in Fig. 1. The left side of the whole system is the plasma production chamber, while the right end of the facility is the deposition chamber. The connecting chamber houses the diagnostic system for the ion beam source (Okabe et al., 1991). The Ti target is connected to a water-cooled copper electrode, which is biased negatively with respect to the plasma. The energy provided by the potential difference accelerates the positive ions across the plasma sheath and into the Ti target. Ti⁺ ions are then produced and self-extracted into the diagnostic system.

A turbo molecular pump backed by a rotary pump evacuates the ion production chamber and it normally attains a base pressure of 5.0 x 10⁻⁶ Torr. The oxygen/argon plasma is produced at initial gas filling pressures of 3.15 x 10⁻⁵ Torr O₂ and 6.7 x 10⁻³ Torr argon. Operating parameters for the discharge are discharge current (I_d) = -0.8 A, discharge voltage (V_d) = -40 V, target voltage (V_t) = -200 V, target current (I_t) = -30 mA and filament current (I_f) = 8.5 A. It is at these settings that quiescent plasma was achieved. Discharge and target currents fluctuates to a minimum at these settings.

After the ignition of the plasma, a Langmuir probe trace is taken so as to determine critical parameters of the discharge such as the electron density, electron temperature and the plasma potential. The Langmuir probe setup can be seen in Fig. 2, which shows that the tip of the probe is located at the center of the plasma. Subsequently, the energy spectrum is determined using a retarding potential-type ESA (Fig. 3) which is located inside the connecting chamber. A retractable bellows-type feedthrough is connected to the ESA so that the longitudinal energy spectrum can be determined. Data gathering from the Langmuir probe and the ESA is simplified by interfacing the data acquisition instruments.
into an Intel-based computer via the general programmable interface bus (GPIB) protocol. The GPIB protocol has an advantage over most computer interface systems since the GPIB computer interface card does not introduce digital noise unlike normal analog-to-digital interface cards. The software is written in visual C++ so as to simplify the user-interface. The results are then recorded for data processing and analysis after the experiment.

Fig. 2. Top cross section view of the production chamber including the connection setup for the Langmuir probe.

Fig. 3. Schematic diagram of the retarding potential-type energy analyzer.
RESULTS AND DISCUSSION

Langmuir probe measurements

A sample Langmuir trace is obtained and shown in Fig. 4a. The pertinent ambient parameters can then be derived from this particular trace. In the absence of any other external field sources, the electron distribution is primarily Maxwellian (Huddlestone and Leonard, 1965).

The region of concern for the determination of the electron temperature $T_e$ occurs in the transition region, where the electron accelerates and builds up in the Langmuir probe producing the rising current. The shape of the transition curve of the Langmuir trace is related to the distribution of electron energies and hence gives the parameter $T_e$. Since the distribution follows a Maxwellian profile, the sloping rise is exponential in nature. Taking the variation of the logarithm of the current as a function of the voltage (Fig. 4b), the slope is directly proportional to the Maxwellian exponential power $|e/kT_e|$ where $e$ is the electron charge and $k$ is Boltzmann’s constant. Linear regression analysis yields the log equation $y = 0.0017e^{0.5419x}$ and the computed electron temperature is $T_e = 2.14 \times 10^4$ K. The magnitude of the saturation electron current is a measure of $n(kT_e)^{1/2}$, from which the electron density
n = 9.2 x 10^6 cm^-3 is determined. These values fall within the range of typical of glow discharge plasmas (Garcia 1997).

The plasma potential is derived via extrapolation of the saturation and transition regions. The calculated plasma space potential is 6.8 volts. The strong positive value of the plasma space potential implies that both electrons and negative titanium ions are confined within the plasma which could result in a relatively high ion density being extracted and detected.

When the probe is sufficiently negative, only ions can reach the probe surface. Since the motion of the ions are not significantly affected by the potential across the sheath due to their masses, the ions are expected to reach the probe surface at their random thermal speed. This means that the rate of the number of ions reaching the probe is independent of the probe potential as long as it is sufficiently negative. This contributes to the ion saturation current which is a result of the random thermal motions of the ions and is given by

\[ I_n = 0.4 A e n \left( \frac{2kT_e}{m_i} \right)^{1/2} \]  \hspace{1cm} (1)

where A is the effective probe area, e is the electron charge, \( n_i \) is the ion density and \( T_e \) is the electron temperature, \( k \) is the Boltzmann constant and \( m_i \) is the ion mass.

The electron random current gives the current contributed by the electron flow

\[ I_e = A e n \left( \frac{kT_e}{2\pi m_e} \right)^{1/2} \]  \hspace{1cm} (2)

The calculated current values are \( I_n = 3.25 \times 10^{-4} \) A and \( I_e = 1.92 \times 10^{-3} \) A. These readings, too are valid within an order of magnitude to derived results (Garcia, 1997).

**ESA traces**

A retarding-potential type ESA interfaced via a GPIB bus is utilized to derive the transverse energy profile of the confined plasma. The various ESA traces at different transverse displacements \( Z \) are presented in

Fig. 5. The value of \( Z \) is minimum at the base of the chamber and increases as the probe is scanned up the chamber's diameter. It is evident that the ESA provides detectable response only within the 20-40 mm range. The plots of the maximum detected current as a function of transverse displacement \( Z \) are given in Fig. 6. The current full-width-at-half-maximum (FWHM) occurs within the 15-40 mm range. Beyond this diameter, very low current value is obtained. This plot presents a qualitative profile of the distribution of the intensity of the plasma beam along its cross-section. For deposition applications where the target substrate has a surface area of 1 cm^2, this cross-section is large and may severely deplete the incident beam of its intensity because intensity varies inversely with illuminated area. If not focused properly, the target substrate can be swamped by the incident ions and deposition efficiency will be severely compromised.

As the plasma propagate along the length of the chamber, a significant broadening of the angular distribution of the sputtered species is encountered. This defocusing effect is caused by the large angular extent of the target, the initial cosine-like sputter emission distribution (Huddleston and Leonard, 1965) and the collision broadening of this distribution (Backhouse et al., 1996).

The energy distribution of the Ti ions from a plasma sputter source is described by (Ramos et al., 1989; Ramos et al., 1990; Alton, 1989)

\[ Y^\theta = 2\pi \frac{\delta}{\theta} \frac{u}{v} \int f(E, \theta) \eta(E, \theta) \sin \theta d\theta \]  \hspace{1cm} (3)

where the energy distribution of particles ejected by sputtering is described by the Thomson relation (Thomson, 1968).

\[ f(E, \theta) = \frac{\pi}{\pi} \frac{E}{E + E_b} \cos \theta \]  \hspace{1cm} (4)

E_b = 4.85 eV is the surface binding energy of the particle to the solid. The negative ion production probability is (Ishikawa, 1988).
Fig. 5. ESA traces for different longitudinal displacements $Z$. Operating parameters for the discharge are discharge current $= -0.8\, \text{A}$, discharge voltage $= -40\, \text{V}$, target voltage $= -200\, \text{V}$, target current $= -30\, \text{mA}$, and filament current $= 8.5\, \text{A}$.

Fig. 6. Plot of maximum ESA current for different transverse displacements. Operating parameters for the discharge are discharge current $= -0.8\, \text{A}$, discharge voltage $= -40\, \text{V}$, target voltage $= -200\, \text{V}$, target current $= -30\, \text{mA}$, and filament current $= 8.5\, \text{A}$.
\begin{equation}
\eta(E, \theta) = \frac{2}{\pi} \exp \left[ \frac{(\phi - E_a)}{\gamma v_N / c} \right]
\end{equation}

where

\begin{align*}
v_N &= \sqrt{\frac{2E}{M}} \cos \theta \\
\gamma / c &= 3 \times 10^{-7} \text{ eV cm}^{-1} \text{s} \\
M &= 47.9, \text{ mass of Ti} \\
E_a &= 0.2 \text{ eV, electron affinity} \\
\phi &= 3.7 \sim 4.3 \text{ eV, Ti work function}
\end{align*}

The plot of \(Y\) as a function of the ejection angle \((-\pi/2 \leq \theta \leq \pi/2)\) is presented in Fig. 7A for \(E=200 \text{ V}\). This gaussian curve concentrates most of the ions near the propagation axis of the chamber and is similar to and supports the results in Fig. 6.

Should the ESA be moved in the axial direction, it is possible to determine a cylindrical profile of the energy spectrum and hence the beam divergence can be quantitatively characterized. Many pertinent information can then be extracted from the data including the description of the energy requirements for respectable Ti deposition, the degree of defocus encountered by the beam and the three-dimensional distribution of the current, temperature and even electrical conductivity of the plasma. However, since the existing set-up is constrained to move only along
the beam cross-section, numerical approximations shall be utilized as an alternative in gauging the deposition performance of the set-up.

The negative ion current can be obtained using the equation

\[ I^- = \eta^- Y I^+ \]  \hspace{1cm} (6)

where \( I^+ \) is the positive ion current for sputtering. The sputtering yield of the metal is (Matsunami et al., 1984)

\[ Y = 0.42 \frac{\alpha Q \Sigma_n(e)}{\mu_s [1 + 0.35 \mu_s S_n(e)]} \left[ 1 - \left( \frac{E_n}{E} \right)^{1/2} \right]^{2.8} \]  \hspace{1cm} (7)

where

- \( \mu_s = 4.85 \text{ eV} \) = sublimation energy
- \( \alpha = 0.194 \)
- \( Q = \text{equal parameter} \)
- \( S_n(e) = \text{stopping cross section} \)
- \( \varepsilon = \text{reduced energy} \)
- \( E_n = \text{threshold energy} \)
- \( E = \text{energy} \)

The simulated \( \eta^- Y \) distribution is plotted in Fig. 7b as a function of voltage E. In order to derive the expected negative ion current, we multiply the value of this distribution at \( E = 200 \text{ V} \) by the maximum random
current derived from the Langmuir. The maximum negative ion current drawn from the ESA plot is 0.143 nA which is three orders of magnitude less than the expected Ti ion current. This attenuation is due to the defocusing encountered by the beam.

Proper characterization of the transverse energy content of the plasma involves the determination of the energy spectrum per ESA trace. The energy spectrum of the plasma beam incident on the ESA can be calculated by taking the FWHM of the first derivative of the ESA current with the potential. The numerical differentiation algorithm employed makes use of the central difference approach (Matsunami et al., 1984). The resulting derivative plot in Fig. 8a is plagued with spurious noise due to numerical quantization. The noise is filtered out using the "moving averages" approach with a period of 20 (Excel Macro Options; MicroCal Origin) The resulting trendline is the solid line plot in Fig. 8a.

If the preceding approach is applied to the different SA readings in Fig. 5, it is possible to derive the behavior of the energy spectrum as a function of Z. The resulting cross-sectional distribution of the energy spectrum is plotted in Fig. 8b. The amplitude of the plot represents the degree of variation of the energy as a function of distance Z. The deviation of the order of magnitude is less when it is near the propagation axis than when it is far from the axis. Thus, near the beam center, the ions are not monoenergetic (the energy spread proportional to the spectrum amplitude of the plot). The ideal case is an equal energy spread for all displacements. But since the maximum spread derived from the plot is a mere 8 eV, the system can function as a monoenergetic ion source.

CONCLUSION

The transverse energy distribution of a Ti ion beam is investigated and the deposition capability of the system is characterized using a GPIB-controlled electrostatic energy analyzer (ESA). The plasma operational parameters are derived via a Langmuir probe indicating an electronic density of $9.2 \times 10^{10}$ cm$^{-3}$ and temperature of $2.14 \times 10^4$ K at the beam. Because of beam defocusing, the plasma source can only produce an energy spread of 8 eV. Compared with the accepted implantation energy requirement (10-400 keV) (Walther et al., 1990), the present set-up is inadequate for proper deposition. Future research entails the use of an electrostatic Einzel lens that focuses the divergent beam onto the target substantially increasing the Ti yield.

REFERENCES


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